

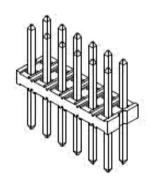
Part Number : <u>877583050</u>

Product Description : 2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 30 Circuits, 0.38μm Gold (Au) Selective Plating, Tray Packaging, Lead-Free

Series Number: 87758

Status: Active

Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

877583050 sd.pdf

PK-89990-487-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-87761-100-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	e per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87758
Description	2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tray Packaging, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348310814

Agency

UL	E29179
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Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Physical

Breakaway	Yes
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	94V-0 No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	5.50mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	0.834/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.60mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole
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Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	250

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Dual Row Receptacle Housings	<u>51110</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>78787</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>78788</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79107</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79108</u>
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	<u>79109</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>87381</u>

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